

Product Compliance Declaration

Please see <u>www.molex.com</u> for the most up-to-date information.

Contact Information

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

Part Information

Part Number 0022233034 Part Weight 0.39G

Part Name KK 100 Hdr Assy Flk Stg Tin 03 Ckt Wht

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
KK 100 Hdr Assy Flk Stg Tin 03 Ckt Wht	Assembly		100	0.39
KK 100 Hdr Flk 03 Ckt Wht	Component		58.4615	0.228
PBT GF NATURAL	Material		58.4615	0.228
PBT	Substance		37.5824	0.146571
GF-Fibre	Substance		4.0088	0.015634
Flame Retardant, ISO 1043-4 FR(17)	Substance		12.9451	0.050486
Antimonytrioxide	Substance	1309-64-4	3.4242	0.013354
Further Additives, not to declare	Substance	system	0.5011	0.001954
.590 x .0261 Sq Brass Bando Pin Tin	Assembly		41.5385	0.162
.590 x .0261 Sq Brass Bando Pin Unplated	Component		40	0.156
Cartridge Brass 70% Unplated	Material		40	0.156
Copper	Substance	7440-50-8	28	0.1092
Zinc (metal)	Substance	7440-66-6	12	0.0468

Form Rev - F

Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Tin Plating	Material		0.6923	0.0027
Tin	Substance	7440-31-5	0.6923	0.0027
Nickel Plating	Material		0.8462	0.0033
Nickel	Substance	7440-02-0	0.8461	0.0033
Further Additives, not to declare	Substance	system	8E-05	3E-07

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2020)9139-DC (19 Jan 2021)

Contained Substances Exceeding Threshold

None

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
lead	Cartridge Brass 70% (CA260)	*Note	350	Yes
lead	e-plate Sn (electrodeposited Tin	*Note	500	Yes

Form Rev - F

Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Antimonytrioxide	PBT GF NATURAL	*Note	70,000	Yes
nickel powder [particle diameter < 1 mm]	Ep-Ni	*Note	997,500	Yes
copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes
glass, oxide, chemicals	PBT GF NATURAL	*Note	80,000	Yes

^{*}Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

Exemptions

Part Name	Exemption
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/cm2/week)

HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Bromine and its compounds	PBT GF NATURAL	900	250,000	Yes
Bromine and Chlorine combined	PBT GF NATURAL	1,500	250,000	Yes

China ROHS Declaration Information

Part Number	0022233034							
Part Name	KK 100 Hdr Assy Flk Stg Tin 03 Ckt Wht	(e)						
Part Information	on			Ha	zardous S	Substance	es	
Components			Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
KK 100 Hdr A	Assy Flk Stg Tin 03 Ckt Wht		0	0	0	0	0	0
KK 100 Hdr F	Flk 03 Ckt Wht		0	0	0	0	0	0

Form Rev - F

Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Components	Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
.590 x .0261 Sq Brass Bando Pin Tin	0	0	0	0	0	0
.590 x .0261 Sq Brass Bando Pin Unplated	0	0	0	0	0	0

Process Information

Component Plating / Surface Finish	MSn-RNi
Termination Base Alloy	Brass
Solder Alloy	N/A
Process Capability	WAVE
Maximum Exposure Time (seconds)	005
Maximum Process Temperature (C)	235
Maximum Cycles at Reflow Temperature	001
J-STD-020 Moisture Sensitivity Level	N/A

Mar 24, 2021